IPC ASSOCIATION ELECTRONIE	© Copyright 2005	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			nder both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				•	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materia					als and Mfg Information			
upplie	r Information														
Company name*				Company unique ID			Unique ID Authority					Response Date*			
nsemi												2023-06-08			
Contact N	lame		Title - Contact			F	Phone - Contact*				Email - Contact*				
Product-l	Env-Stewards		Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com				
uthorize	ed Representative*	Title - Representative			F	Phone - Representative*				Email - Representative*					
Product-	Env-Stewards	Product Enviro Compliance]	NA				Product-Env-Stewards@onsemi.com					
	Requester Item Number Mfr Item		n Number Mfr Item Name				Effective Date	ctive Date		ring Site	1	Weight*	UOM	Unit Type	
		FAN3227CMX Dual		Dual 2A Low-Side	Dual 2A Low-Side Drive		2023-06-08 TH2		TH2		8	33.484	mg	Each	
Ianufa	ecturing Process Inform							•							
	8		,		-STD-020 MSL	Rating		ess Bod	ss Body Temperature Max Time at Peak		ime at Peak			er of Reflow Cyc	eles
	Matte Tin (Sn) - annealed		CU Alloy	1			260		C	30		secon	ds 3		
omments															
	naximum time at peak tempera														
or more	information regarding materi	al composition	please refer t	o page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	led						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recurined by the						
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	2.16	mg	Supplier	Silicon (Si)	7440-21-3		2.16	mg
Die Attach	1.144	mg		Epoxy resin	proprietary data		0.1487	mg
			Supplier	Silver (Ag)	7440-22-4		0.4004	mg
			Supplier	Acrylic resins	Proprietary Data		0.1945	mg
			Supplier	Aluminum (Al)	7429-90-5		0.4004	mg
Lead Frame	31.136	mg	Supplier	Silver (Ag)	7440-22-4		1.5568	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0374	mg
			Supplier	Iron (Fe)	7439-89-6		0.7473	mg
			Supplier	Copper (Cu)	7440-50-8		28.7697	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0249	mg
Mold Compound-Black	45.29	mg	Supplier	4,4'-Bis(2,3-epoxypropoxy)-3,3',5,5'-tetramethylbiphenyl	85954-11-6		2.0381	mg
			Supplier	Carbon Black (C)	1333-86-4		0.2264	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		41.6668	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		1.3587	mg
Plating	3.44	mg	Supplier	Tin (Sn)	7440-31-5		3.44	mg
Wire Bond	0.314	mg	Supplier	Palladium (Pd)	7440-05-3		0.0097	mg
			Supplier	Gold (Au)	7440-57-5		0.0011	mg
			Supplier	Copper (Cu)	7440-50-8		0.3032	mg